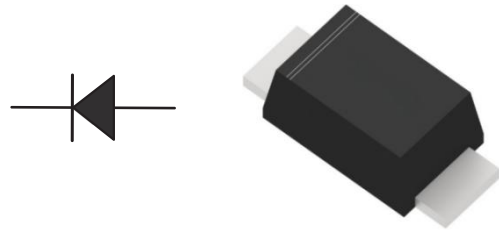


Surface Mount Schottky Barrier Rectifier

Parameter	Value	Unit
V_{RRM}	20~200	V
$I_{F(AV)}$	1.0	A



SOD-123FL

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability

Applications

- For use in low-voltage, high-frequency inverters, free-wheeling applications, DC/DC converters, and polarity protection circuits.

Absolute Maximum Ratings and Characteristics (at $T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	SS12L	SS14L	SS16L	SS18L	SS110L	SS112L	SS115L	SS120L	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1.0								A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	30								A
Max Instantaneous Forward Voltage at 1A	V_F	0.55		0.70		0.85		0.9		V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 100^\circ\text{C}$	I_R		0.3			0.2		0.1		mA
			10			5		2		
Typical Junction Capacitance (1)	C_j	110		80						pF
Typical Thermal Resistance (2)	$R_{\theta JA}$	100								$^\circ\text{C/W}$
Operating Junction Temperature Range	T_j	-55 ~ +125	-55 ~ +150							$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 ~ +150								$^\circ\text{C}$

Notes:

- (1) Measured at 1 MHz and applied reverse voltage of 4 V D.C
- (2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Typical characteristics

Fig.1 Forward Current Derating Curve

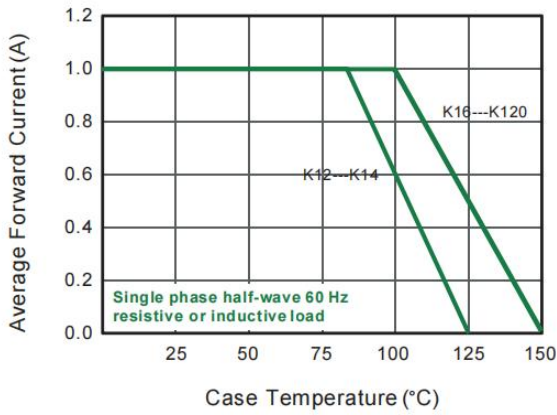


Fig.2 Typical Reverse Characteristics

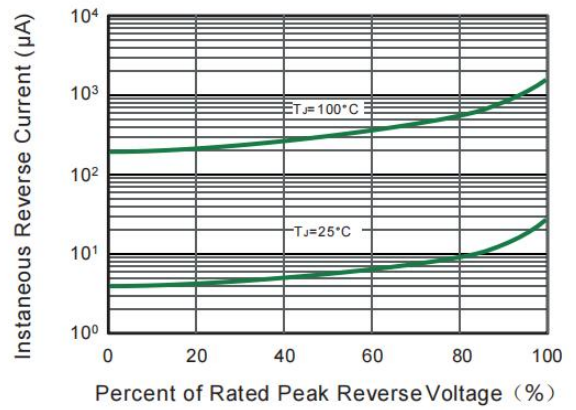


Fig.3 Typical Forward Characteristic

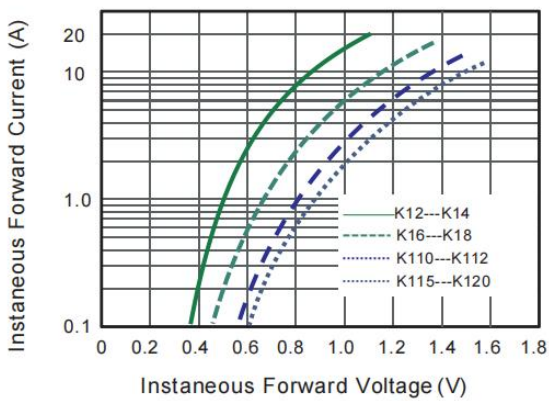


Fig.4 Typical Junction Capacitance

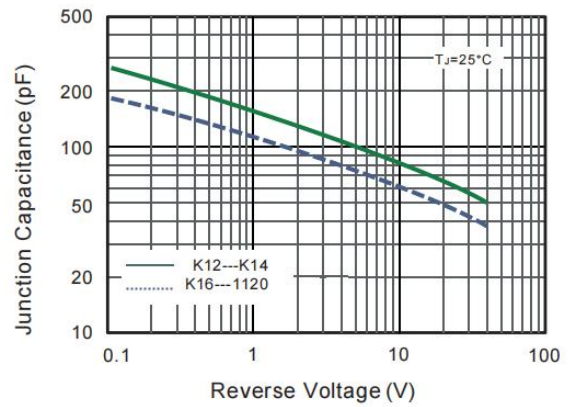


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

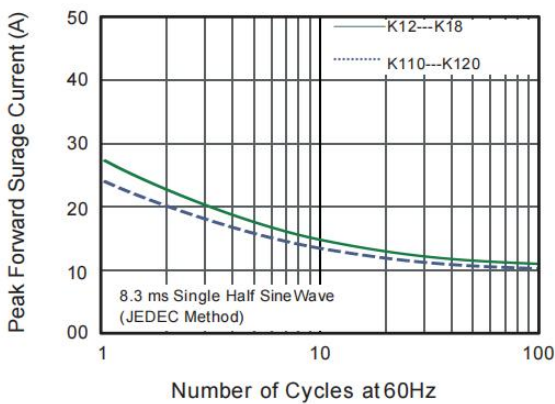
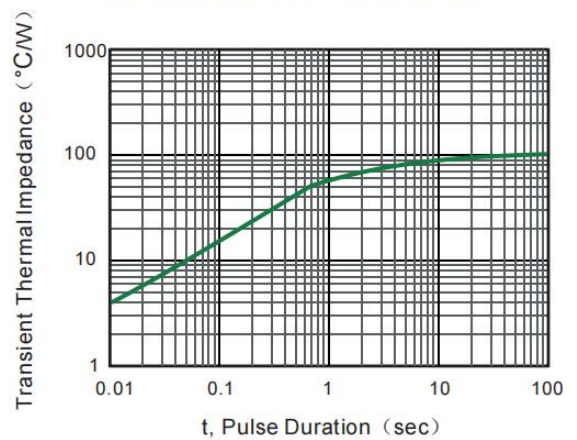


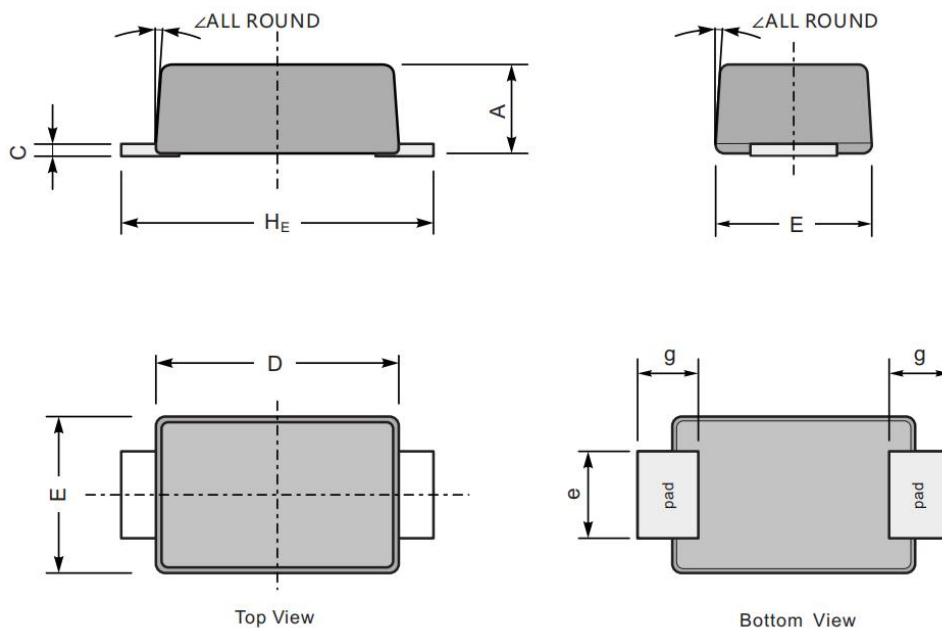
Fig.6- Typical Transient Thermal Impedance



Package outlines

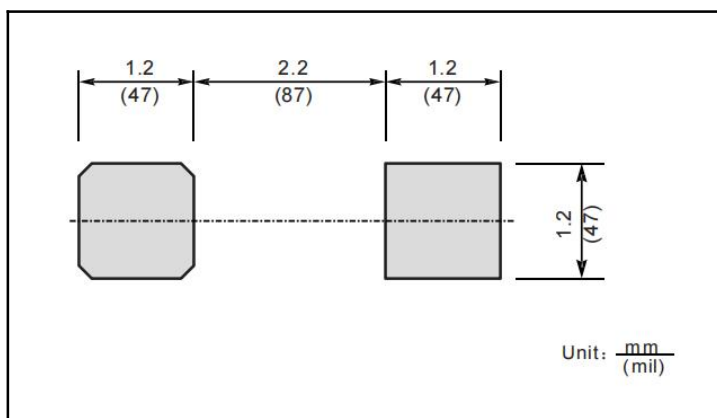
Plastic surface mounted package; 2 leads

SOD-123FL



UNIT		A	C	D	E	e	g	B	∠
mm	max	1.15	0.20	2.8	2.0	1.2	0.9	3.8	5°
	min	0.95	0.12	2.5	1.7	0.9	0.7	3.5	
mil	max	45	7.9	110	78.7	47	35	150	
	min	37	4.7	98	67	35	28	138	

The recommended mounting pad size



Marking

Type number	Marking code
SS12L	K12
SS14L	K14
SS16L	K16
SS18L	K18
SS110L	K110
SS112L	K112
SS115L	K115
SS120L	K120

***Important Usage Information and Disclaimer**

The specifications of Zhuhai Hypersemi Co., Ltd. products are not guarantees of product characteristics. They reflect typical performance expected in standard applications, which may vary with specific uses. Users must conduct prior testing for their applications and make necessary adjustments.

Users are responsible for the safety of applications utilizing our products and must implement adequate safety measures to prevent physical injury, fire, or other risks in case of product failure. It is the user's duty to ensure that application designs comply with all applicable laws and standards. Our products must not be used in any applications where a product failure could reasonably result in personal injury, unless specifically authorized in a signed document by Zhuhai Hypersemi Co., Ltd.

No representations or warranties are made regarding the accuracy or completeness of this information, including any claims of non-infringement of third-party intellectual property rights. Zhuhai Hypersemi Co., Ltd. assumes no liability for any applications or uses of its products and does not grant any licenses to its intellectual property rights or those of others. We also make no claims regarding non-infringement of third-party intellectual property rights that may arise from applications.

Due to technical requirements, our products may contain hazardous substances. For details, please contact your nearest sales office. This document replaces all previous information and may be updated. We reserve the right to make changes.